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High voltage fast-switching NPN power transistor

Preliminary data

Features

- STI13005-1 is opposite pin out versus standard IPAK package
- High voltage capability
- Low spread of dynamic parameters
- Very high switching speed

Application

Switch mode power supplies (AC-DC converters)



The device is manufactured using high voltage multi-epitaxial planar technology for high switching speeds and high voltage capability. It uses a cellular emitter structure with planar edge termination to enhance switching speeds while maintaining the wide RBSOA.

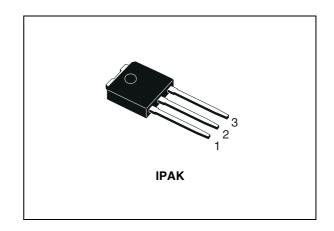


Figure 1. Internal schematic diagram

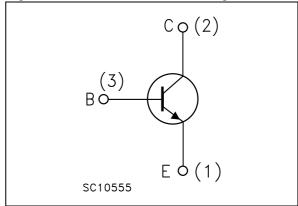


Table 1. Device summary

Order code	Marking	Package	Packaging
STI13005-1	l13005	IPAK	Tube

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Electrical ratings STI13005-1

1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{CES}	Collector-emitter voltage (V _{BE} = 0)	700	V
V _{CEO}	Collector-emitter voltage (I _B = 0)	400	V
V _{EBO}	Emitter-base voltage ($I_C = 0$; $I_B = 1.5 \text{ A}$; $t_p < 10 \text{ ms}$)	V _{(BR)EBO}	٧
I _C	Collector current	3	Α
I _{CM}	Collector peak current (t _P < 5 ms)	6	Α
I _B	Base current	1.5	Α
I _{BM}	Base peak current (t _P < 5 ms)	3	Α
P _{TOT}	Total dissipation at T _c = 25 °C	30	W
T _{STG}	Storage temperature	-65 to 150	°C
TJ	Max. operating junction temperature	150	°C

Table 3. Thermal data

	Symbol	Parameter	Value	Unit
ĺ	R_{thJC}	Thermal resistance junction-case max	4.2	°C/W

2 Electrical characteristics

 T_{case} = 25 °C unless otherwise specified.

Table 4. Electrical characteristics

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{CES}	Collector cut-off current (V _{BE} = 0)	V _{CE} = 700 V V _{CE} = 700 V T _C = 125 °C			1 5	mA mA
I _{CEO}	Collector-cut-off current (I _B = 0)	V _{CE} = 400 V			1	mA
V _{(BR)EBO}	Emitter base breakdown voltage $(I_C = 0)$	I _E = 10 mA	9		18	V
V _{CEO(sus)} (1)	Collector-emitter sustaining voltage (I _B = 0)	I _C = 10 mA	400			V
V _{CE(sat)} (1)	Collector-emitter saturation voltage	$\begin{split} I_C &= 1 \text{A} & I_B = 200 \text{ mA} \\ I_C &= 2 \text{A} & I_B = 500 \text{ mA} \\ I_C &= 3 \text{A} & I_B = 750 \text{ mA} \end{split}$			0.5 0.6 5	>
V _{BE(sat)} (1)	Base-emitter saturation voltage	$I_C = 1A$ $I_B = 200 \text{ mA}$ $I_C = 2A$ $I_B = 500 \text{ mA}$			1.2 1.6	V V
h _{FE} ⁽¹⁾	DC current gain	$\begin{split} I_C &= 500 \; \mu A & V_{CE} &= 2 \; V \\ I_C &= 425 \; mA & V_{CE} &= 2 \; V \\ I_C &= 1 \; A & V_{CE} &= 5 \; V \\ I_C &= 2 \; A & V_{CE} &= 5 \; V \end{split}$	15 24 10 8		30 24	
t _s	Resistive load Storage time Fall time	$I_C = 2 A$ $V_{CC} = 125 V$ $I_{B1} = -I_{B2} = 400 \text{ mA}$ $I_p = 30 \mu\text{s}$		1.65 260		μs ns
t _s	Inductive load Storage time Fall time	$\begin{split} I_{C} &= 1 \text{ A} & V_{clamp} = 300 \text{ V} \\ I_{B1} &= 200 \text{ mA } V_{BE(off)} = -5 \text{ V} \\ L &= 50 \text{ mH} & R_{BB} = 0 \end{split}$		0.8 150		μs ns

^{1.} Pulse test: pulse duration \leq 300 μ s, duty cycle \leq 2 %

Electrical characteristics STI13005-1

2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

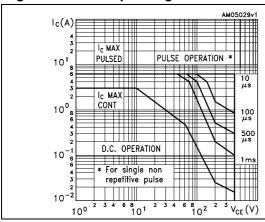


Figure 3. Derating curve

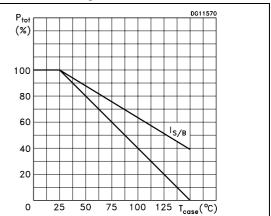


Figure 4. Reverse biased SOA

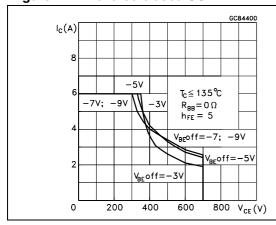


Figure 5. Output characteristics

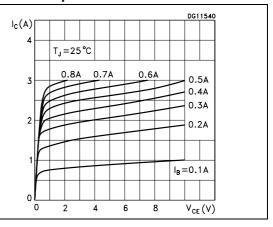


Figure 6. DC current gain $(V_{CE} = 1 V)$

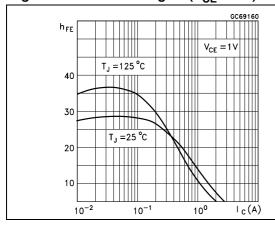
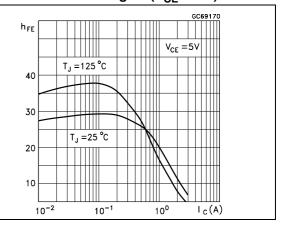


Figure 7. DC current gain $(V_{CE} = 5 V)$



 $h_{FE} = 5$

 $I_{c}(A)$

Figure 8. Collector-emitter saturation voltage Figure 9. **Base-emitter saturation voltage**

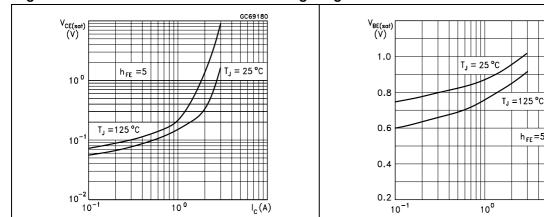


Figure 10. Inductive load fall time

Figure 11. Inductive load storage time

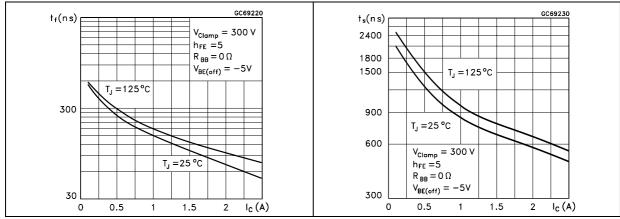
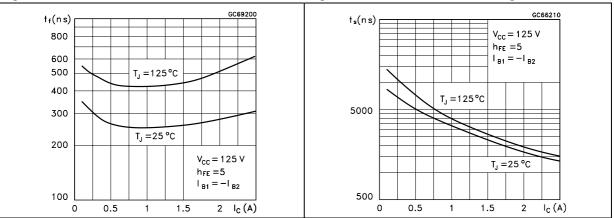


Figure 12. Resistive load fall time

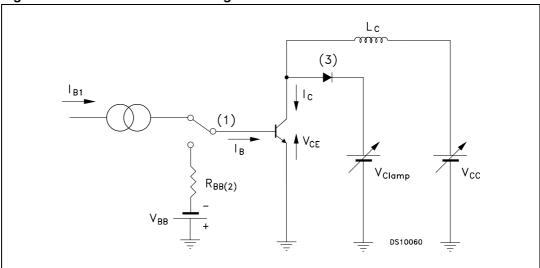
Figure 13. Resistive load storage time



Test circuits STI13005-1

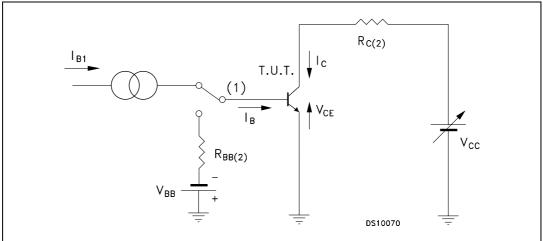
3 Test circuits

Figure 14. Inductive load switching test circuit



- 1) Fast electronic switch
- 2) Non-inductive resistor
- 3) Fast recovery rectifier

Figure 15. Resistive load switching test circuit



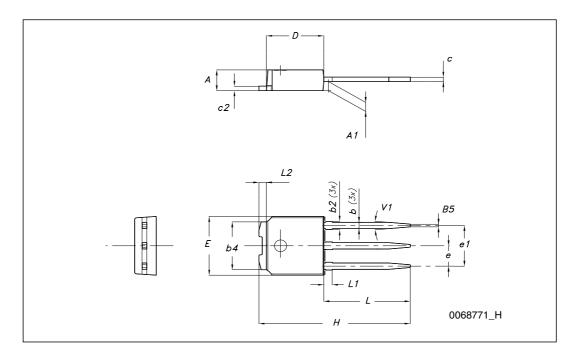
- 1) Fast electronic switch
- 2) Non-inductive resistor

4 Package mechanical data

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TO-251	(IPAK)	mechanical	data
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DIM.	mm.			
DIIVI.	min.	typ	max.	
Α	2.20		2.40	
A1	0.90		1.10	
b	0.64		0.90	
b2			0.95	
b4	5.20		5.40	
С	0.45		0.60	
c2	0.48		0.60	
D	6.00		6.20	
E	6.40		6.60	
е		2.28		
e1	4.40		4.60	
Н		16.10		
L	9.00		9.40	
(L1)	0.80		1.20	
L2		0.80		
V1		10 °		



STI13005-1 Revision history

5 Revision history

Table 5. Document revision history

Date	Revision	Changes
18-Feb-2010	1	First release.

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